

GaAs INTEGRATED CIRCUIT $\mu PG2158T5K$

L, S-BAND SPDT SWITCH

DESCRIPTION

The μ PG2158T5K is a GaAs MMIC for L, S-band SPDT (Single Pole Double Throw) switch which was developed for mobile phone and another L, S-band application.

This device can operate 2 control switching by control voltage 1.8 to 5.3 V. This device can operate frequency from 0.05 to 3.0 GHz, having the low insertion loss and high isolation.

This device is housed in a 6-pin plastic TSSON (<u>Thin Shrink Small Out-line Non-leaded</u>) package. And this package is able to high-density surface mounting.

FEATURES

•	Switch control voltage	: V _{cont (H)} = 1.8 to 5.3 V (2.7 V TYP.)
		: $V_{\text{cont (L)}} = -0.2 \text{ to } +0.2 \text{ V} (0 \text{ V TYP.})$
•	Low insertion loss	: LINS1 = 0.40 dB TYP. @ f = 0.05 to 1.0 GHz, Vcont (H) = 2.7 V, Vcont (L) = 0 V
		: LINS2 = 0.45 dB TYP. @ f = 1.0 to 2.0 GHz, Vcont (H) = 2.7 V, Vcont (L) = 0 V
		: LINS3 = 0.47 dB TYP. @ f = 2.0 to 2.5 GHz, Vcont (H) = 2.7 V, Vcont (L) = 0 V
		: LINS4 = 0.53 dB TYP. @ f = 2.5 to 3.0 GHz, Vcont (H) = 2.7 V, Vcont (L) = 0 V
٠	High isolation	: ISL1 = 27 dB TYP. @ f = 0.05 to 1.0 GHz, V _{cont (H)} = 2.7 V, V _{cont (L)} = 0 V
		: ISL2 = 19 dB TYP. @ f = 1.0 to 2.0 GHz, Vcont (H) = 2.7 V, Vcont (L) = 0 V
		: ISL3 = 17 dB TYP. @ f = 2.0 to 2.5 GHz, V _{cont (H)} = 2.7 V, V _{cont (L)} = 0 V
		: ISL4 = 17 dB TYP. @ f = 2.5 to 3.0 GHz, $V_{cont (H)} = 2.7 V$, $V_{cont (L)} = 0 V$
•	Handling power	: Pin (0.1 dB) = +29.0 dBm TYP. @ f = 2.0/2.5 GHz, Vcont (H) = 2.7 V, Vcont (L) = 0 V
		: Pin (1 dB) = +30.5 dBm TYP. @ f = 2.0/2.5 GHz, V cont (H) = 2.7 V, V cont (L) = 0 V
٠	High-density surface mounting	: 6-pin plastic TSSON package ($1.0 \times 1.0 \times 0.37$ mm)

APPLICATIONS

- L, S-band digital cellular or cordless telephone
- W-LAN, WLL and Bluetooth[™] etc.

ORDERING INFORMATION

Part Number	Order Number	Package	Marking	Supplying Form
<i>µ</i> РG2158T5K-E2	μPG2158T5K-E2-A	6-pin plastic TSSON (Pb-Free) ^{Note}	G2	 Embossed tape 8 mm wide Pin 1, 6 face the perforation side of the tape Qty 5 kpcs/reel

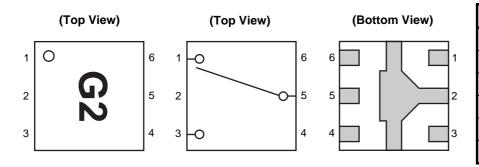
Note With regards to terminal solder (the solder contains lead) plated products (conventionally plated), contact your nearby sales office.

Remark To order evaluation samples, contact your nearby sales office. Part number for sample order: μ PG2158T5K-A

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



Pin No.	Pin Name
1	OUTPUT1
2	GND
3	OUTPUT2
4	Vcont2
5	INPUT
6	Vcont1

TRUTH TABLE

V _{cont} 1	V _{cont} 2	INPUT-OUTPUT1	INPUT-OUTPUT2
Low	High	OFF	ON
High	Low	ON	OFF

ABSOLUTE MAXIMUM RATINGS (TA = +25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Switch Control Voltage	Vcont	+6.0 ^{Note}	V
Input Power	Pin	+31	dBm
Operating Ambient Temperature	TA	-45 to +85	°C
Storage Temperature	Tstg	–55 to +150	°C

Note $|V_{cont}1 - V_{cont}2| \le 6.0 V$

RECOMMENDED OPERATING RANGE (TA = +25°C, unless otherwise specified)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Switch Control Voltage (H)	Vcont (H)	1.8	2.7	5.3	V
Switch Control Voltage (L)	Vcont (L)	-0.2	0	+0.2	V

ELECTRICAL CHARACTERISTICS 1

(TA = +25°C, V_{cont} (H) = 2.7 V, V_{cont} (L) = 0 V, DC cut capacitors = 56 pF, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss 1	Lins1	f = 0.05 to 1.0 GHz ^{Note 1}	-	0.40	0.45	dB
Insertion Loss 2	Lins2	f = 1.0 to 2.0 GHz	-	0.45	0.50	
Insertion Loss 3	Lins3	f = 2.0 to 2.5 GHz	-	0.47	0.55	
Insertion Loss 4	Lins4	f = 2.5 to 3.0 GHz	-	0.53	0.60	
Isolation 1	ISL1	f = 0.05 to 1.0 GHz ^{Note 1}	23	27	-	dB
Isolation 2	ISL2	f = 1.0 to 2.0 GHz	16	19	-	
Isolation 3	ISL3	f = 2.0 to 2.5 GHz	14	17	-	
Isolation 4	ISL4	f = 2.5 to 3.0 GHz	14	17	-	
Input Return Loss	RLin	f = 0.05 to 3.0 GHz Note 1	15	20	-	dB
Output Return Loss	RLout	f = 0.05 to 3.0 GHz ^{Note 1}	15	20	-	dB
0.1 dB Loss Compression	Pin (0.1 dB)	f = 2.0/2.5 GHz	+26.0	+29.0	-	dBm
Input Power Note 2		f = 0.5 to 3.0 GHz	-	+29.0	-	
1 dB Loss Compression Input Power ^{Note 3}	Pin (1 dB)	f = 0.5 to 3.0 GHz	_	+30.5	-	dBm
2nd Harmonics	2fo	f = 2.0/2.5 GHz, P _{in} = +20 dBm	65	75	-	dBc
3rd Harmonics	3fo	f = 2.0/2.5 GHz, P _{in} = +20 dBm	65	75	-	dBc
Input 3rd Order Distortion Intercept Point	IIP3	f = 0.5 to 3.0 GHz 2 tone 5 MHz spacing	_	+60	-	dBm
Switch Control Current	Icont	No signal	-	0.2	20	μA
Switch Control Speed	tsw	50% CTL to 90/10% RF	-	50	500	ns

Notes 1. DC cut capacitors = 1000 pF at f = 0.05 to 0.5 GHz

- **2.** P_{in (0.1 dB)} is measured the input power level when the insertion loss increases more 0.1 dB than that of linear range.
- **3.** Pin (1 dB) is measured the input power level when the insertion loss increases more 1 dB than that of linear range.

Caution This device is used it is necessary to use DC cut capacitors.

The value of DC cut capacitors should be chosen to accommodate the frequency of operation, bandwidth, switching speed and the condition with actual board of your system. The range of recommended DC cut capacitor value is less than 100 pF.

ELECTRICAL CHARACTERISTICS 2

(TA = +25°C, V_{cont} (H) = 1.8 V, V_{cont} (L) = 0 V, DC cut capacitors = 56 pF, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss 1	Lins1	f = 0.05 to 1.0 GHz ^{Note 1}	-	0.40	0.47	dB
Insertion Loss 2	Lins2	f = 1.0 to 2.0 GHz	-	0.46	0.52	
Insertion Loss 3	Lins3	f = 2.0 to 2.5 GHz	-	0.48	0.57	
Insertion Loss 4	Lins4	f = 2.5 to 3.0 GHz	-	0.54	0.62	
Isolation 1	ISL1	f = 0.05 to 1.0 GHz ^{Note 1}	23	27	-	dB
Isolation 2	ISL2	f = 1.0 to 2.0 GHz	16	19	-	
Isolation 3	ISL3	f = 2.0 to 2.5 GHz	14	17	-	
Isolation 4	ISL4	f = 2.5 to 3.0 GHz	14	17	-	
Input Return Loss	RLin	f = 0.05 to 3.0 GHz ^{Note 1}	15	20	-	dB
Output Return Loss	RLout	f = 0.05 to 3.0 GHz ^{Note 1}	15	20	-	dB
0.1 dB Loss Compression	P in (0.1 dB)	f = 2.0/2.5 GHz	+19.0	+22.0	-	dBm
Input Power ^{Note 2}		f = 0.5 to 3.0 GHz	-	+22.0	-	
1 dB Loss Compression Input Power ^{Note 3}	Pin (1 dB)	f = 0.5 to 3.0 GHz	-	+25.0	-	dBm
Switch Control Current	Icont	No signal	-	0.2	20	μA
Switch Control Speed	tsw	50% CTL to 90/10% RF	_	50	500	ns

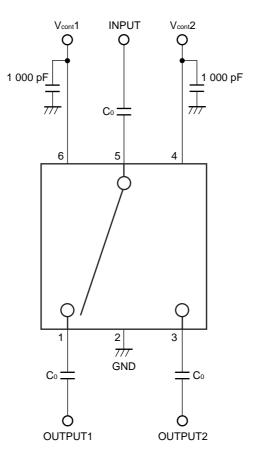
Notes 1. DC cut capacitors = $1\ 000\ pF$ at f = 0.05 to 0.5 GHz

- **2.** P_{in (0.1 dB)} is measured the input power level when the insertion loss increases more 0.1 dB than that of linear range.
- **3.** Pin (1 dB) is measured the input power level when the insertion loss increases more 1 dB than that of linear range.

Caution This device is used it is necessary to use DC cut capacitors.

The value of DC cut capacitors should be chosen to accommodate the frequency of operation, bandwidth, switching speed and the condition with actual board of your system. The range of recommended DC cut capacitor value is less than 100 pF.

EVALUATION CIRCUIT



Remark C₀ : 0.05 to 0.5 GHz 1 000 pF : 0.5 to 3.0 GHz 56 pF

The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

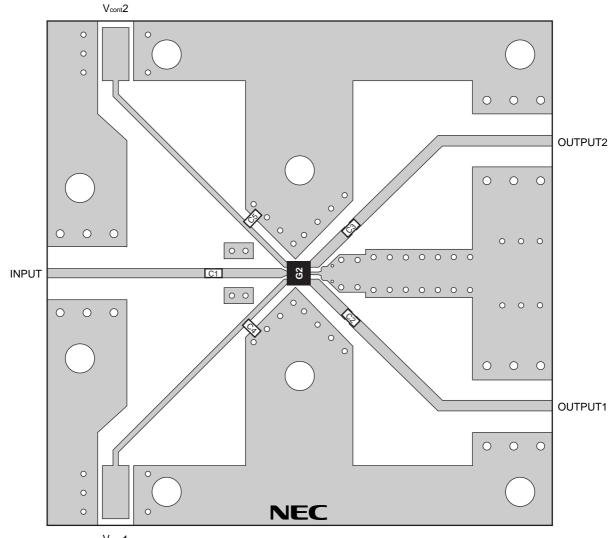


ILLUSTRATION OF THE TEST CIRCUIT ASSEMBLED ON EVALUATION BOARD

 $V_{\text{cont}}\mathbf{1}$

USING THE NEC EVALUATION BOARD

Symbol	Values
C1, C2, C3	56 pF
C4, C5	1 000 pF

-0.380 dB

1.0 GHz

1.5 GHz

-0.413 dB

-0.446 dB 2.0 GHz

-0.468 dB

2.5 GHz -0.511 dB

3.0 GHz

3.5

5

∆ 5

2.9

1: -27.239 dB

-23.849 dB

1.0 GHz

1.5 GHz

-21.47 dB

2.0 GHz

2.5 GHz

3.0 GHz

3.5

25.098 dB

1.0 GHz

27.928 dB 1.5 GHz

28.894 dB

2.0 GHz

28.293 dB

-26.879 dB 3.0 GHz

<u>∽</u> 5

2.9

2.5 GHz

19.834 dB

-18,109 dB 5.

²⁵

2.9

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2.3

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2.3

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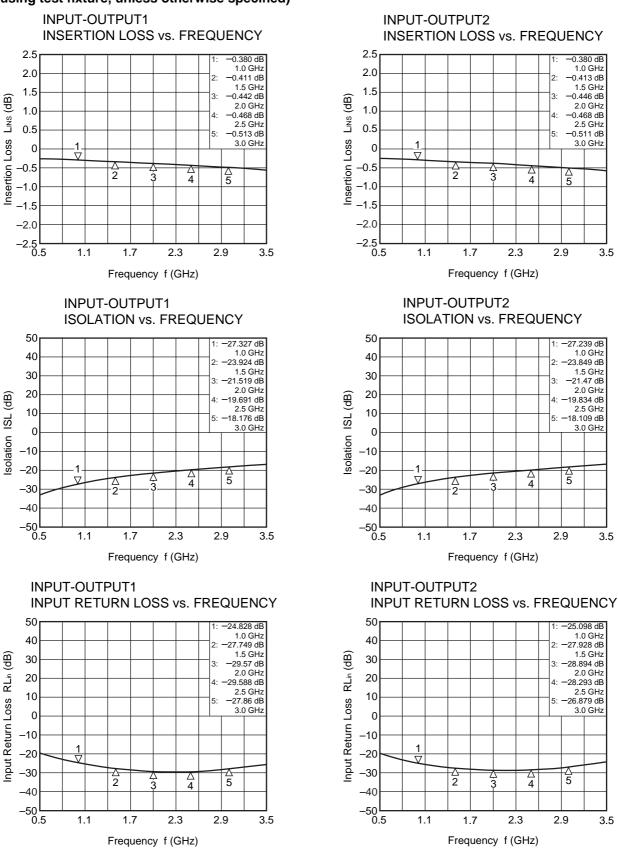
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2.3

-∆ 3

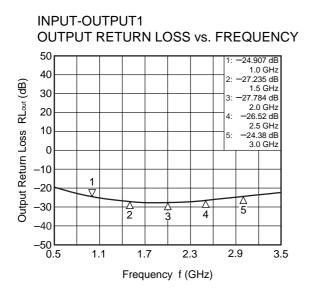
TYPICAL CHARACTERISTICS (TA = +25°C, Vcont (H) = 2.7 V, Vcont (L) = 0 V, DC cut capacitors = 56 pF, using test fixture, unless otherwise specified)

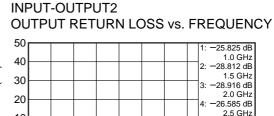


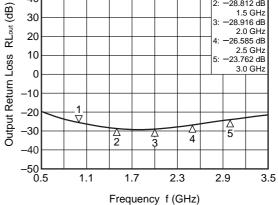
Remark The graphs indicate nominal characteristics.

Data Sheet PG10578EJ02V0DS

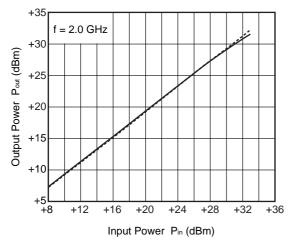
3.5







OUTPUT POWER vs. INPUT POWER

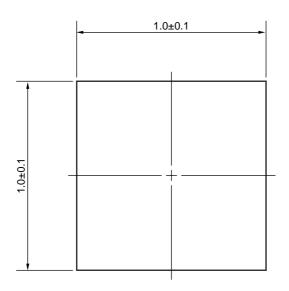


Remark The graphs indicate nominal characteristics.

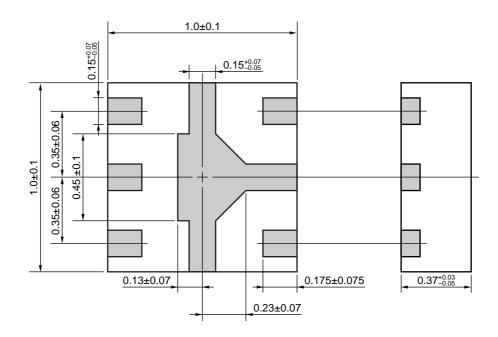
★ PACKAGE DIMENSIONS

6-PIN PLASTIC TSSON (UNIT: mm)

(Top View)







RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions	Condition Symbol	
Infrared Reflow	Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below	IR260
Wave Soldering	Peak temperature (molten solder temperature) Time at peak temperature Preheating temperature (package surface temperature) Maximum number of flow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 120°C or below : 1 time : 0.2%(Wt.) or below	WS260
Partial Heating	Peak temperature (terminal temperature) Soldering time (per side of device) Maximum chlorine content of rosin flux (% mass)	: 350°C or below : 3 seconds or less : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).



Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentratio in CEL	
Lead (Pb)	< 1000 PPM	-A Not Detected	-AZ (*)
Mercury	< 1000 PPM	Not Detected	
Cadmium	< 100 PPM	Not Detected	
Hexavalent Chromium	Ilent Chromium < 1000 PPM Not Dete		etected
РВВ	< 1000 PPM	Not Detected	
PBDE	< 1000 PPM	Not Detected	

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

In no event shall CEL's liability arising out of such information exceed the total purchase price of the CEL part(s) at issue sold by CEL to customer on an annual basis.

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